74AUP2G02

Low-power dual 2-input NOR gate Rev. 7 — 4 February 2013

Product data sheet

General description 1.

The 74AUP2G02 provides a dual 2-input NOR function.

Schmitt trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V o 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing a damaging backflow current through the device when it is powered down.

2. **Features and benefits**

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
 - ◆ JESD8-12 (0.8 V to 1.3 V)
 - ◆ JESD8-11 (0.9 V to 1.65 V)
 - JESD8-7 (1.2 V to 1.95 V)
 - ◆ JESD8-5 (1.8 V to 2.7 V)
 - ◆ JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 5000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; I_{CC} = 0.9 μA (maximum)
- Latch-up performance exceeds 100 mA per JESD78B Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



3. Ordering information

Table 1. Ordering information

| Type number | Package | | | | | | | | | |
|-------------|-------------------|--------|---|----------|--|--|--|--|--|--|
| | Temperature range | Name | Description | Version | | | | | | |
| 74AUP2G02DC | –40 °C to +125 °C | VSSOP8 | plastic very thin shrink small outline package; 8 leads; body width 2.3 mm | SOT765-1 | | | | | | |
| 74AUP2G02GT | –40 °C to +125 °C | XSON8 | plastic extremely thin small outline package; no leads; 8 terminals; body 1 \times 1.95 \times 0.5 mm | SOT833-1 | | | | | | |
| 74AUP2G02GF | –40 °C to +125 °C | XSON8 | extremely thin small outline package; no leads; 8 terminals; body 1.35 \times 1 \times 0.5 mm | SOT1089 | | | | | | |
| 74AUP2G02GD | –40 °C to +125 °C | XSON8 | plastic extremely thin small outline package; no leads; 8 terminals; body 3 \times 2 \times 0.5 mm | SOT996-2 | | | | | | |
| 74AUP2G02GM | –40 °C to +125 °C | XQFN8 | plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 \times 1.6 \times 0.5 mm | SOT902-2 | | | | | | |
| 74AUP2G02GN | –40 °C to +125 °C | XSON8 | extremely thin small outline package; no leads; 8 terminals; body 1.2 \times 1.0 \times 0.35 mm | SOT1116 | | | | | | |
| 74AUP2G02GS | –40 °C to +125 °C | XSON8 | extremely thin small outline package; no leads; 8 terminals; body 1.35 \times 1.0 \times 0.35 mm | SOT1203 | | | | | | |

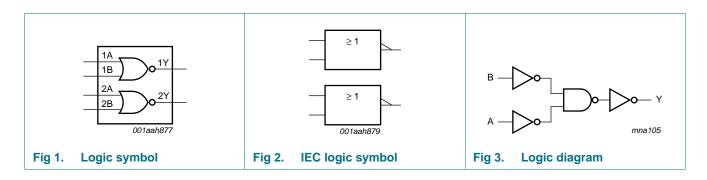
4. Marking

Table 2. Marking codes

| Type number | Marking code ^[1] |
|-------------|-----------------------------|
| 74AUP2G02DC | p02 |
| 74AUP2G02GT | p02 |
| 74AUP2G02GF | рВ |
| 74AUP2G02GD | p02 |
| 74AUP2G02GM | p02 |
| 74AUP2G02GN | рВ |
| 74AUP2G02GS | рВ |

^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram

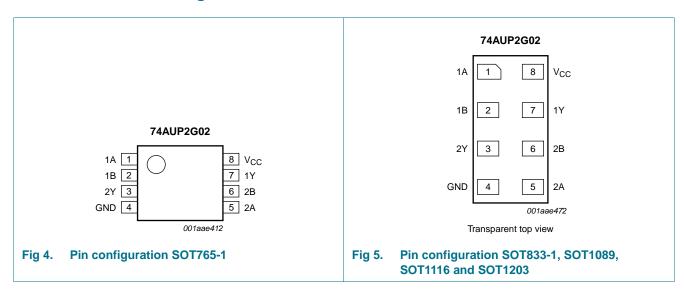


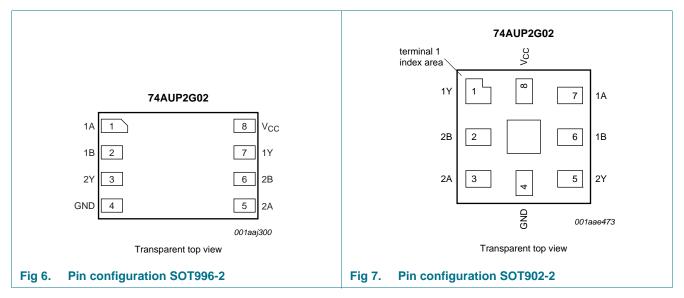
74AUP2G02

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6. Pinning information

6.1 Pinning





6.2 Pin description

Table 3. Pin description

| Symbol | Pin | | Description |
|----------|---|----------|----------------|
| | SOT765-1, SOT833-1, SOT1089, SOT996-2, SOT1116 and SOT1203 | SOT902-2 | |
| 1A, 2A | 1, 5 | 7, 3 | data input |
| 1B, 2B | 2, 6 | 6, 2 | data input |
| GND | 4 | 4 | ground (0 V) |
| 1Y, 2Y | 7, 3 | 1, 5 | data output |
| V_{CC} | 8 | 8 | supply voltage |

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7. Functional description

Table 4. Function table[1]

| Input | | Output |
|-------|----|--------|
| nA | nB | nY |
| L | L | Н |
| L | Н | L |
| Н | L | L |
| Н | Н | L |

^[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|-----------------|------|------|
| V _{CC} | supply voltage | | -0.5 | +4.6 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| V_{I} | input voltage | | <u>[1]</u> –0.5 | +4.6 | V |
| I _{OK} | output clamping current | V _O < 0 V | -50 | - | mA |
| Vo | output voltage | Active mode and Power-down mode | <u>[1]</u> –0.5 | +4.6 | V |
| I _O | output current | $V_O = 0 V \text{ to } V_{CC}$ | - | ±20 | mA |
| I _{CC} | supply current | | - | +50 | mA |
| I _{GND} | ground current | | -50 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ | [2] _ | 250 | mW |

^[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 6. Operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|-------------------------------------|--|-----|----------|------|
| V_{CC} | supply voltage | | 8.0 | 3.6 | V |
| V_{I} | input voltage | | 0 | 3.6 | V |
| Vo | output voltage | Active mode | 0 | V_{CC} | V |
| | | Power-down mode; V _{CC} = 0 V | 0 | 3.6 | V |
| T _{amb} | ambient temperature | | -40 | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ | 0 | 200 | ns/V |

^[2] For VSSOP8 packages: above 110 °C the value of P_{tot} derates linearly with 8.0 mW/K. For XSON8 and XQFN8 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|---|--|----------------------|-----|----------------------|------|
| T _{amb} = 2 | 25 °C | | | | | |
| V _{IH} | HIGH-level input voltage | $V_{CC} = 0.8 \text{ V}$ | $0.70 \times V_{CC}$ | - | - | V |
| | | V _{CC} = 0.9 V to 1.95 V | $0.65 \times V_{CC}$ | - | - | V |
| | | V _{CC} = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | V _{CC} = 3.0 V to 3.6 V | 2.0 | - | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 0.8 \text{ V}$ | - | - | $0.30 \times V_{CC}$ | V |
| | | V _{CC} = 0.9 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | - | - | 0.7 | V |
| | | V _{CC} = 3.0 V to 3.6 V | - | - | 0.9 | V |
| V _{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_{O} = -20 \mu A$; $V_{CC} = 0.8 \text{ V}$ to 3.6 V | $V_{CC}-0.1$ | - | - | V |
| | | $I_O = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | $0.75 \times V_{CC}$ | - | - | V |
| | | $I_O = -1.7 \text{ mA}$; $V_{CC} = 1.4 \text{ V}$ | 1.11 | - | - | V |
| | | $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.32 | - | - | V |
| | | $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 2.05 | - | - | V |
| | | $I_O = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.9 | - | - | V |
| | | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.72 | - | - | V |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.6 | - | - | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = 20 \mu A$; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ | - | - | 0.1 | V |
| | | I _O = 1.1 mA; V _{CC} = 1.1 V | - | - | $0.3 \times V_{CC}$ | V |
| | | $I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | - | - | 0.31 | V |
| | | $I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.31 | V |
| | | $I_O = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.31 | V |
| | | $I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.44 | V |
| | | $I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.31 | V |
| | | $I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.44 | V |
| l _l | input leakage current | $V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V | - | - | ±0.1 | μΑ |
| I _{OFF} | power-off leakage current | V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V | - | - | ±0.2 | μΑ |
| ΔI_{OFF} | additional power-off leakage current | V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V | - | - | ±0.2 | μΑ |
| I _{CC} | supply current | V_I = GND or V_{CC} ; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V | - | - | 0.5 | μΑ |
| ΔI_{CC} | additional supply current | $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$ | [1] - | - | 40 | μΑ |
| Cı | input capacitance | $V_{CC} = 0 \text{ V to } 3.6 \text{ V; } V_{I} = \text{GND or } V_{CC}$ | - | 0.8 | - | pF |
| Co | output capacitance | $V_O = GND; V_{CC} = 0 V$ | - | 1.7 | - | pF |

Low-power dual 2-input NOR gate

 Table 7.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|--------------------------------------|--|-----------------------|-----|----------------------|------|
| T _{amb} = - | 40 °C to +85 °C | | | | | |
| V_{IH} | HIGH-level input voltage | V _{CC} = 0.8 V | $0.70 \times V_{CC}$ | - | - | V |
| | | V _{CC} = 0.9 V to 1.95 V | $0.65 \times V_{CC}$ | - | - | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.6 | - | - | V |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 2.0 | - | - | V |
| V_{IL} | LOW-level input voltage | V _{CC} = 0.8 V | - | - | $0.30 \times V_{CC}$ | V |
| | | V _{CC} = 0.9 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | - | - | 0.7 | V |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | - | - | 0.9 | V |
| V _{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_{O} = -20 \mu A$; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ | V _{CC} - 0.1 | - | - | V |
| | | $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | $0.7 \times V_{CC}$ | - | - | V |
| | | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | 1.03 | - | - | V |
| | | $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.30 | - | - | V |
| | | $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.97 | - | - | V |
| | | $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.85 | - | - | V |
| | | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.67 | - | - | V |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.55 | - | - | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | I_O = 20 μ A; V_{CC} = 0.8 V to 3.6 V | - | - | 0.1 | V |
| | | I _O = 1.1 mA; V _{CC} = 1.1 V | - | - | $0.3 \times V_{CC}$ | V |
| | | $I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | - | - | 0.37 | V |
| | | $I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.35 | V |
| | | $I_O = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.33 | V |
| | | $I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.45 | V |
| | | $I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.33 | V |
| | | $I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.45 | V |
| I _I | input leakage current | $V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V | - | - | ±0.5 | μΑ |
| I _{OFF} | power-off leakage current | V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V | - | - | ±0.5 | μΑ |
| ΔI_{OFF} | additional power-off leakage current | V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V | - | - | ±0.6 | μА |
| I _{CC} | supply current | V_I = GND or V_{CC} ; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V | - | - | 0.9 | μΑ |
| ΔI_{CC} | additional supply current | $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$ | [1] - | - | 50 | μА |

 Table 7.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Тур | Max | Uni |
|----------------------|---|--|------------------------|-----|----------------------|-----|
| T _{amb} = - | 40 °C to +125 °C | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 0.8 V | $0.75 \times V_{CC}$ | - | - | ٧ |
| | | V _{CC} = 0.9 V to 1.95 V | $0.70 \times V_{CC}$ | - | - | V |
| | | V_{CC} = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 2.0 | - | - | V |
| V_{IL} | LOW-level input voltage | V _{CC} = 0.8 V | - | - | $0.25 \times V_{CC}$ | V |
| | | V _{CC} = 0.9 V to 1.95 V | - | - | $0.30 \times V_{CC}$ | V |
| | | V _{CC} = 2.3 V to 2.7 V | - | - | 0.7 | V |
| | | V _{CC} = 3.0 V to 3.6 V | - | - | 0.9 | V |
| √oH | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_{O} = -20 \mu A$; $V_{CC} = 0.8 \text{ V}$ to 3.6 V | V _{CC} - 0.11 | - | - | V |
| | | $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | $0.6 \times V_{CC}$ | - | - | V |
| | | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | 0.93 | - | - | V |
| | | $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.17 | - | - | V |
| | | $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.77 | - | - | V |
| | | $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.67 | - | - | V |
| | | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.40 | - | - | V |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.30 | - | - | V |
| / _{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = 20 \ \mu A; \ V_{CC} = 0.8 \ V \ to \ 3.6 \ V$ | - | - | 0.11 | V |
| | | $I_O = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | - | - | $0.33 \times V_{CC}$ | V |
| | | $I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | - | - | 0.41 | V |
| | | I_{O} = 1.9 mA; V_{CC} = 1.65 V | - | - | 0.39 | V |
| | | I_{O} = 2.3 mA; V_{CC} = 2.3 V | - | - | 0.36 | V |
| | | $I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.50 | V |
| | | $I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.36 | V |
| | | $I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.50 | V |
| I | input leakage current | V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V | - | - | ±0.75 | μΑ |
| OFF | power-off leakage current | V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V | - | - | ±0.75 | μΑ |
| ∆l _{OFF} | additional power-off leakage current | V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V | - | - | ±0.75 | μΑ |
| СС | supply current | $V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ | - | - | 1.4 | μА |
| 7l ^{CC} | additional supply current | $V_1 = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$ | [1] - | - | 75 | μΑ |

^[1] One input at V_{CC} – 0.6 V, other input at V_{CC} or GND.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

| Symbol | Parameter | Conditions | | Ta | _{imb} = 25 | °C | T _{amb} = | -40 °C to | +125 °C | Unit |
|-----------------------|-------------------|--|-----|-----|---------------------|------|--------------------|----------------|-----------------|------|
| | | | | Min | Typ[1] | Max | Min | Max (85 °C) | Max (125 °C) | |
| $C_L = 5 pl$ | F | | | | ' | ' | ' | | | |
| t_{pd} | propagation delay | nA, nB to nY; see Figure 8 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 17.0 | - | - | - | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | 2.5 | 5.1 | 10.8 | 2.1 | 12.1 | 13.4 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | 1.6 | 3.7 | 6.7 | 1.4 | 7.8 | 8.6 | ns |
| | | V_{CC} = 1.65 V to 1.95 V | | 1.3 | 3.0 | 5.3 | 1.1 | 6.2 | 6.9 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 1.0 | 2.4 | 3.9 | 0.9 | 4.6 | 5.1 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.0 | 2.2 | 3.4 | 0.8 | 4.0 | 4.4 | ns |
| C _L = 10 p | o F | | | | | | | | | |
| t _{pd} | propagation delay | nA, nB to nY; see Figure 8 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 20.4 | - | - | - | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | 2.4 | 6.0 | 12.8 | 2.2 | 14.3 | 15.8 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | 1.9 | 4.3 | 7.9 | 1.7 | 9.2 | 10.2 | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 1.6 | 3.6 | 6.2 | 1.5 | 7.3 | 8.1 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 1.4 | 3.0 | 4.7 | 1.2 | 5.6 | 6.2 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.3 | 2.7 | 4.2 | 1.2 | 5.0 | 5.5 | ns |
| C _L = 15 p | o F | | | | | | | | | |
| t _{pd} | propagation delay | nA, nB to nY; see Figure 8 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 23.9 | - | - | - | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | 3.4 | 6.8 | 14.6 | 3.1 | 16.4 | 18.1 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | 2.3 | 4.8 | 8.9 | 2.0 | 10.4 | 11.5 | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 1.9 | 4.0 | 7.0 | 1.7 | 8.3 | 9.2 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 1.7 | 3.4 | 5.4 | 1.5 | 6.3 | 7.0 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.6 | 3.2 | 4.8 | 1.4 | 5.7 | 6.3 | ns |
| $C_{L} = 30 \mu$ | o F | | | | | | | | | |
| t _{pd} | propagation delay | nA, nB to nY; see Figure 8 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 34.2 | - | - | - | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | 4.6 | 9.0 | 19.9 | 4.1 | 22.4 | 24.7 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | 3.4 | 6.4 | 11.8 | 2.9 | 13.9 | 15.3 | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 2.6 | 5.3 | 9.3 | 2.3 | 11.1 | 12.3 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 2.4 | 4.5 | 7.1 | 2.1 | 8.5 | 9.4 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 2.3 | 4.2 | 6.4 | 2.1 | 7.7 | 8.5 | ns |

 Table 8.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

| Symbol | Parameter | Conditions | Conditions | | _{mb} = 25 | °C | T _{amb} = | -40 °C to | +125 °C | Unit |
|--------------|-------------------------------|---|------------|--------|--------------------|-----|--------------------|-----------------|---------|------|
| | | | Min | Typ[1] | Max | Min | Max (85 °C) | Max (125 °C) | | |
| $C_L = 5 pF$ | F, 10 pF, 15 pF and | 30 pF | | | | | | | | |
| C_{PD} | power dissipation capacitance | $f_i = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$ | [3] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 2.6 | - | - | - | - | pF |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | - | 2.7 | - | - | - | - | pF |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | - | 2.8 | - | - | - | - | pF |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | - | 2.9 | - | - | - | - | pF |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | - | 3.3 | - | - | - | - | pF |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | - | 3.8 | - | - | - | - | pF |

- [1] All typical values are measured at nominal V_{CC} .
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o) \text{ where:}$

f_i = input frequency in MHz;

 f_0 = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

12. Waveforms

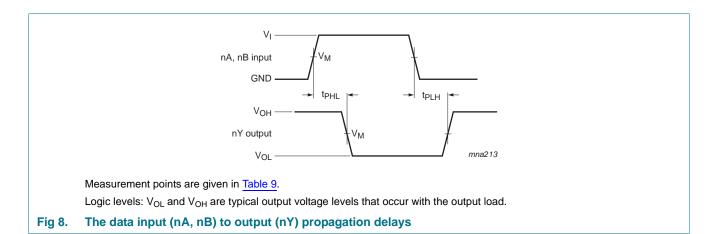
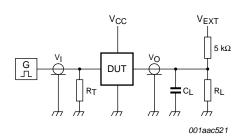


Table 9. Measurement points

| Supply voltage | Output | Input | | | | | | |
|-----------------|---------------------|---------------------|-----------------|-------------|--|--|--|--|
| V _{CC} | V _M | V _M | V _I | $t_r = t_f$ | | | | |
| 0.8 V to 3.6 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | V _{CC} | ≤ 3.0 ns | | | | |

Low-power dual 2-input NOR gate



Test data is given in Table 10.

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

Table 10. Test data

| Supply voltage | Load | | V _{EXT} | | | | |
|-----------------|------------------------------|------------------------------|-------------------------------------|-------------------------------------|-------------------------------------|--|--|
| V _{CC} | C _L | R _L [1] | t _{PLH} , t _{PHL} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} | | |
| 0.8 V to 3.6 V | 5 pF, 10 pF, 15 pF and 30 pF | 5 k Ω or 1 M Ω | open | GND | $2 \times V_{CC}$ | | |

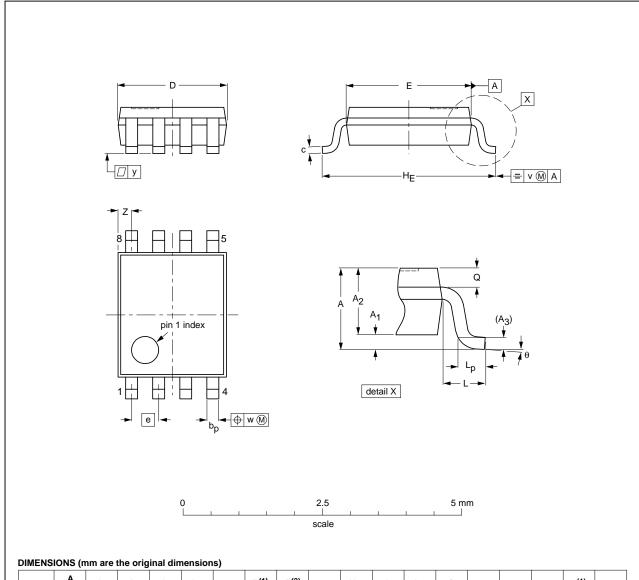
^[1] $R_L = 5 \text{ k}\Omega$ when measuring enable and disable times.

 R_L = 1 $M\Omega$ when measuring propagation delays, set-up and hold times and pulse width.

13. Package outline

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1



| UNIT | A max. | A ₁ | A ₂ | А3 | bp | С | D ⁽¹⁾ | E ⁽²⁾ | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|------|--------------|--------------|------------------|------------------|-----|------------|-----|--------------|--------------|-----|------|-----|------------------|----------|
| mm | 1 | 0.15 0.00 | 0.85 0.60 | 0.12 | 0.27 0.17 | 0.23 0.08 | 2.1 1.9 | 2.4 2.2 | 0.5 | 3.2 3.0 | 0.4 | 0.40 0.15 | 0.21 0.19 | 0.2 | 0.13 | 0.1 | 0.4 0.1 | 8° 0° |

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|----------|-----|--------|----------|------------|------------|------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT765-1 | | MO-187 | | | | 02-06-07 |

Fig 10. Package outline SOT765-1 (VSSOP8)

74AUP2G02

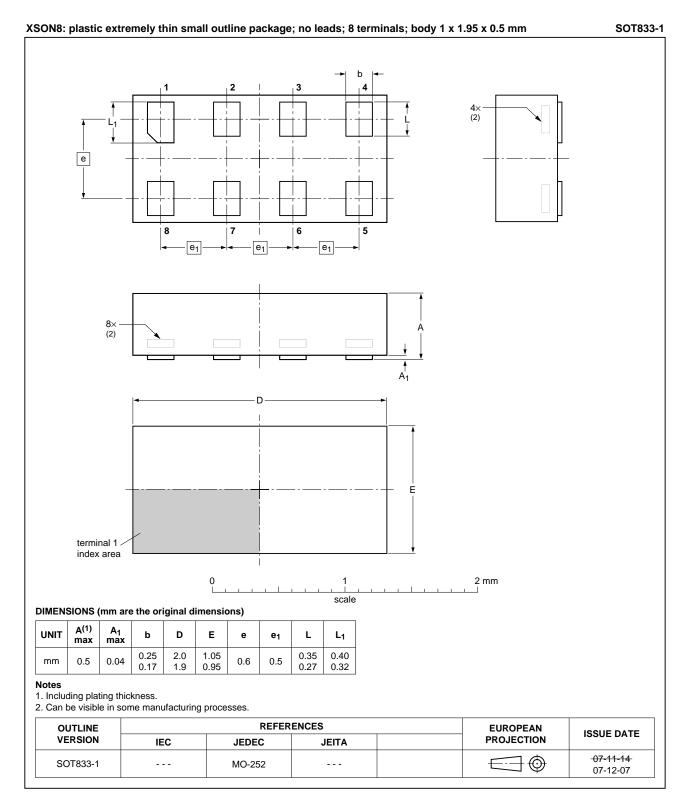


Fig 11. Package outline SOT833-1 (XSON8)

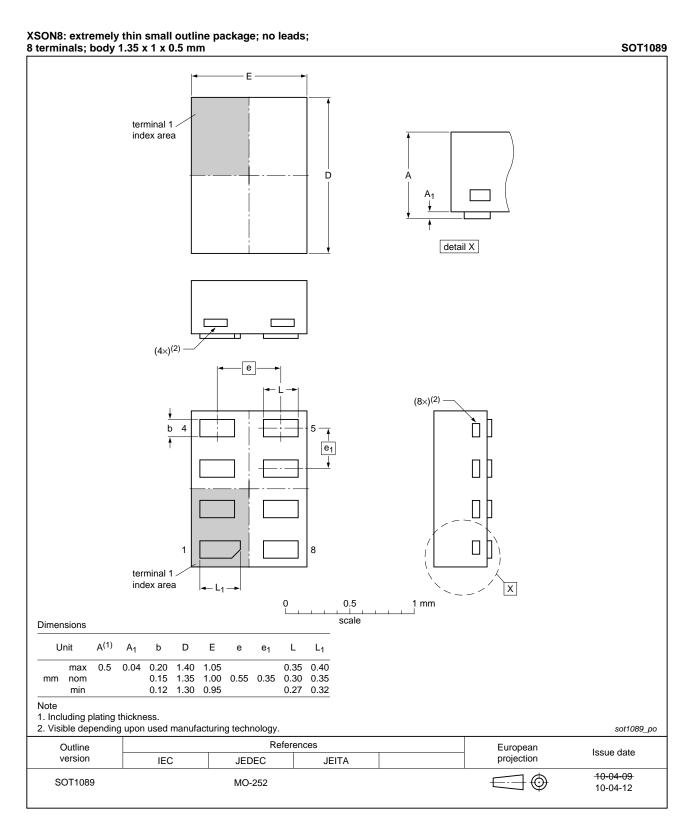


Fig 12. Package outline SOT1089 (XSON8)

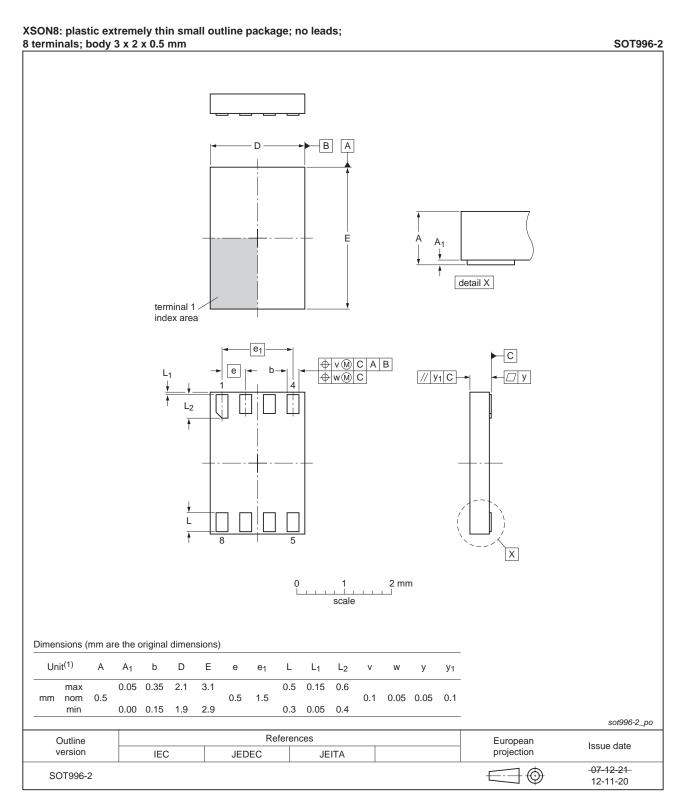


Fig 13. Package outline SOT996-2 (XSON8)

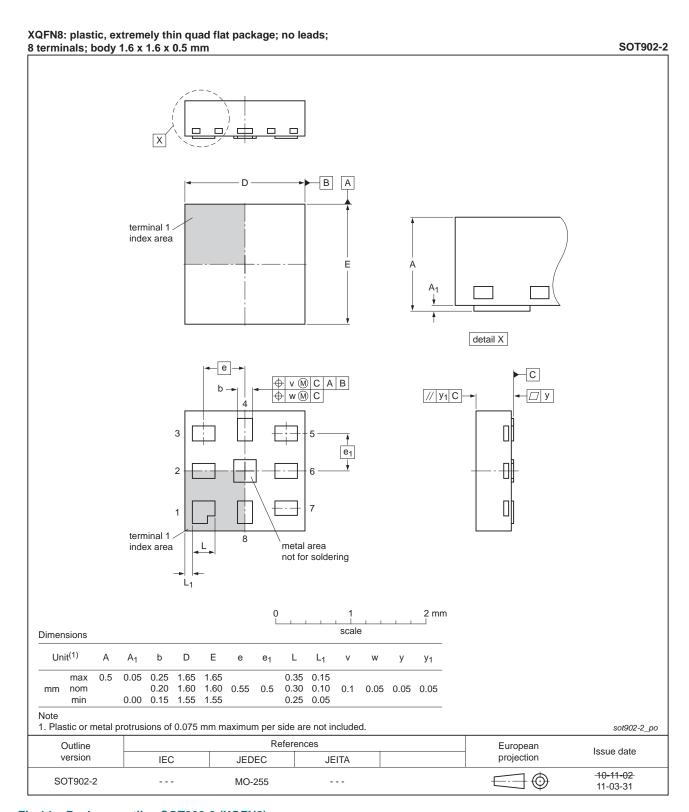


Fig 14. Package outline SOT902-2 (XQFN8)

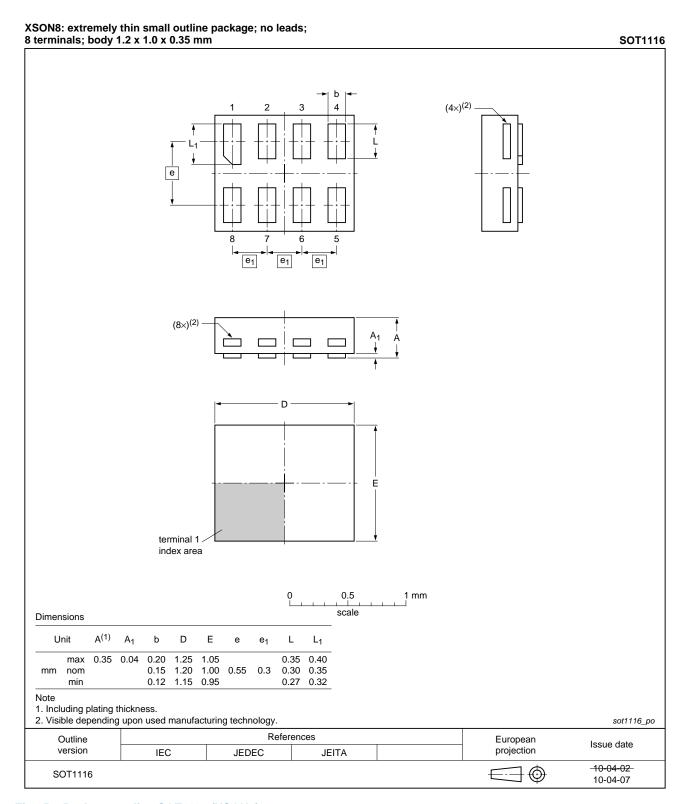


Fig 15. Package outline SOT1116 (XSON8)

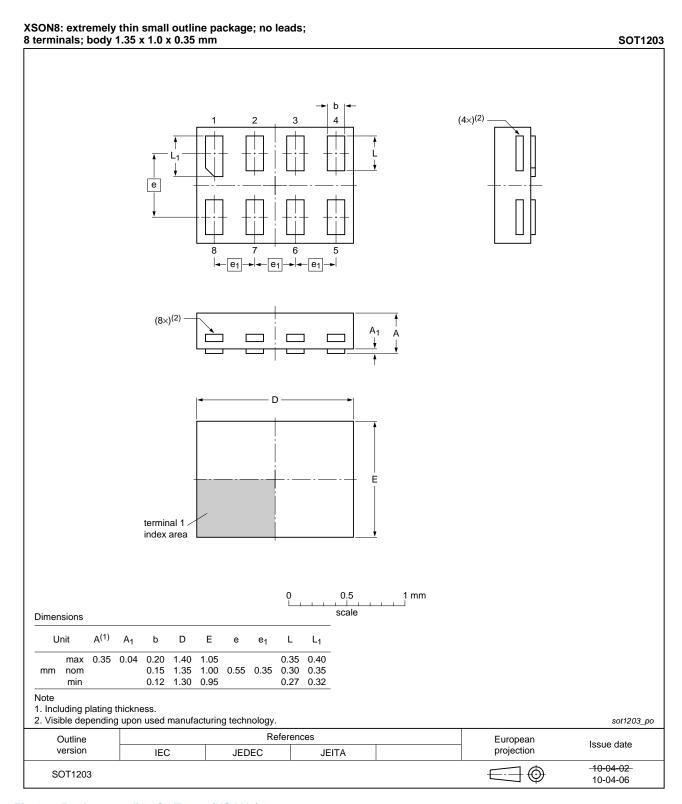


Fig 16. Package outline SOT1203 (XSON8)

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14. Abbreviations

Table 11. Abbreviations

| Acronym | Description |
|---------|-------------------------|
| CDM | Charged Device Model |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| НВМ | Human Body Model |
| MM | Machine Model |

15. Revision history

Table 12. Revision history

| | • | | | |
|----------------|---------------------------------|----------------------|-----------------------|---------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| 74AUP2G02 v.7 | 20130204 | Product data sheet | - | 74AUP2G02 v.6 |
| Modifications: | For type nu | mber 74AUP2G02GD XSC | N8U has changed to XS | SON8. |
| 74AUP2G02 v.6 | 20120803 | Product data sheet | - | 74AUP2G02 v.5 |
| 74AUP2G02 v.5 | 20111202 | Product data sheet | - | 74AUP2G02 v.4 |
| 74AUP2G02 v.4 | 20101109 | Product data sheet | - | 74AUP2G02 v.3 |
| 74AUP2G02 v.3 | 20081211 | Product data sheet | - | 74AUP2G02 v.2 |
| 74AUP2G02 v.2 | 20080319 | Product data sheet | - | 74AUP2G02 v.1 |
| 74AUP2G02 v.1 | 20060828 | Product data sheet | - | - |
| | | | | |

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|--------------------------------|-------------------|---|
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| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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Low-power dual 2-input NOR gate

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